



#### Typical Applications

The HMC748LC3C is ideal for:

- 2:1 Multiplexer up to 14 Gbps
- RF ATE Applications
- Broadband Test & Measurement
- Serial Data Transmission up to 14 Gbps
- · Redundant Path Switching
- Built-in Test

#### **Features**

Supports High Data Rates: up to 14 Gbps

Single-ended inputs

Differential & Single-Ended Outputs

Fast Rise and Fall Times: 22 / 22 ps

Low Power Consumption: 250 mW typ.

Programmable Differential

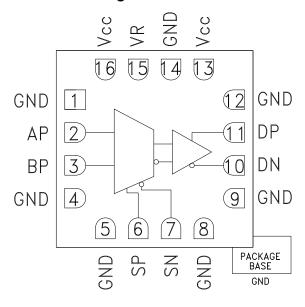
Output Voltage Swing: 600 - 1200 mV

Propagation Delay: 125 ps

Single Supply: +3.3 V

16 Lead Ceramic 3x3 mm SMT Package: 9 mm<sup>2</sup>

#### **Functional Diagram**



#### **General Description**

The HMC748LC3C is a 2:1 Selector designed to support data transmission rates of up to 14 Gbps, and selector port operation of up to 14 GHz. The selector routes one of the two single-ended inputs to the differential output upon assertion of the proper select port. The HMC748LC3C also features an output level control pin, VR, that allows for loss compensation or for signal level optimization.

All select differential inputs to the HMC748LC3C are CML and terminated on-chip with 50 Ohms to the positive supply, Vcc, and may be AC or DC coupled. The single-ended inputs to the HMC748LC3C are CML terminated on-chip with 50 Ohms to the positive supply, GND, and may be DC coupled. The differential CML outputs are source terminated to 50 Ohms and may also be AC or DC coupled. Outputs can be connected directly to a 50 Ohm Vcc terminated system, while DC blocking capacitors may be used if the terminating system is 50 Ohms to ground. The HMC748LC3C operates from a single + 3.3 V supply and is available in ROHS-compliant 3x3 mm SMT package.

# Electrical Specifications, T<sub>A</sub> = +25 °C, Vcc = 3.3 V, VR = 3.3 V

Parameter	Conditions	Min.	Тур.	Max	Units
Power Supply Voltage		3.0	3.3	3.6	٧
Power Supply Current			76		mA
Maximum Data Rate			14		Gbps
Maximum Select Rate			14		GHz
Maximum Serial Transmission Rate			26		Gbps



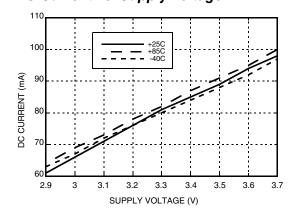


## **Electrical Specifications** (continued)

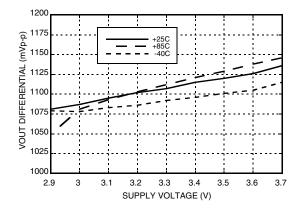
Parameter	Conditions	Min.	Тур.	Max	Units
Input Vcm	Vin = 600 mVp-p	Vcc - 0.375	Vcc - 0.300	Vcc - 0.275	V
Input High Voltage			Vcc - 0.1	Vcc - 0.5	V
Input Low Voltage		Vcc - 0.1	Vcc - 0.5		V
Input Return Loss	Frequency <14 GHz		10		dB
	Single-Ended, peak-to-peak		550		mVp-p
Output Amplitude	Differential, peak-to-peak		1100		mVp-p
Output High Voltage			3.29		V
Output Low Voltage			2.74		V
Output Rise / Fall Time	Differential, 20% - 80%		22 / 22		ps
Output Return Loss	Frequency <13 GHz		10		dB
Random Jitter, Jr	rms <sup>[1]</sup>			0.2	ps rms
Deterministic Jitter, Jd	peak-to-peak, 2 <sup>15</sup> -1 PRBS input [2]		2		ps, p-p
Propagation Delay, A or B to D <sub>OUT</sub> , td			125		ps
Propagation Delay Select to Data, tds			135		ps
Set Up & Hold Time, t <sub>SH</sub>			6		ps
VR Pin Current	VR = 3.3 V		2		mA
VR Pin Current	VR = 3.7 V			3.5	mA

<sup>[1]</sup> Upper limit of random jitter, Jr, determined by measuring and integrating output phase noise with a sinusoidal input at 5, 10, and 13.5 GHz over temperature

## DC Current vs. Supply Voltage [1] [2]



# **Output Differential Voltage** vs. Supply Voltage [1][2]



[1] VR = 3.3 V

[2] Frequency = 13 GHz

[3] Vcc = 3.3 V

<sup>[2]</sup> Deterministic jitter calculated by simultaneously measuring the jitter of a 200 mV, 12.5 GHz, 2<sup>15</sup>-1 PRBS input, and a single-ended output

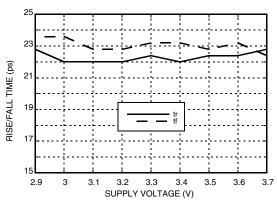


v03.1010

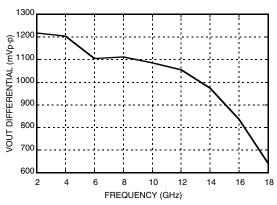


# 14 Gbps, 2:1 SELECTOR w/ PROGRAMMABLE OUTPUT VOLTAGE & POSITIVE SUPPLY

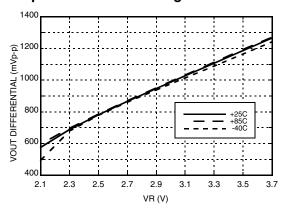
## Rise / Fall Time vs. Supply Voltage [1][2]



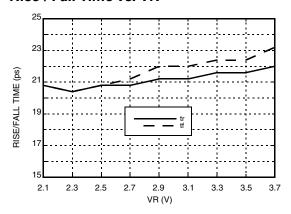
## Output Differential vs. Frequency [1][3]



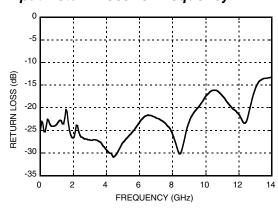
#### Output Differential Voltage vs. VR [1][2]



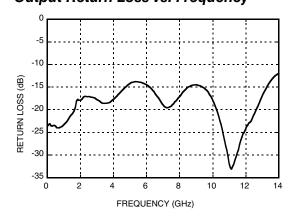
#### Rise / Fall Time vs. VR [1][2]



#### Input Return Loss vs. Frequency



# **Output Return Loss vs. Frequency**



[1] Vcc = 3.3 V

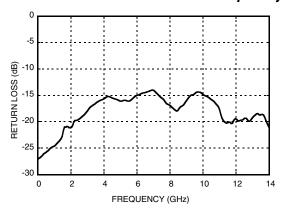
[2] Frequency = 13 GHz

[3] Vcc = 3.3 V

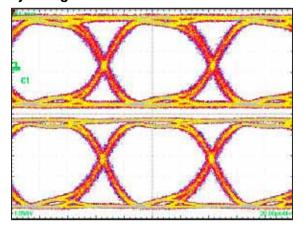




#### Select Port Return Loss vs. Frequency



### Eye Diagram

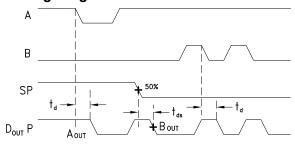


#### [1] Test Conditions:

Waveform generated with an Agilent N4903A J-Bert. Rate = 13 GHz

Eye Diagram data presented on a Tektronix CSA 8000 Device is AC coupled to scope.

#### **Timing Diagram**



td = propagation delay, A or B to Dout tds = propagation delay, Select to Dout

#### **Truth Table**

Inputs	Outputs	
S	DP	
Н	A -> D	
L	B -> D	
H - Positive voltage level L - Negative voltage level		
Notes: D = DP - DN S = SP - SN		



VAVE CONFORMION V03.



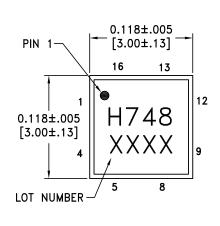
# 14 Gbps, 2:1 SELECTOR w/ PROGRAMMABLE OUTPUT VOLTAGE & POSITIVE SUPPLY

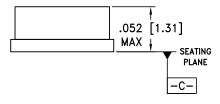
## **Absolute Maximum Ratings**

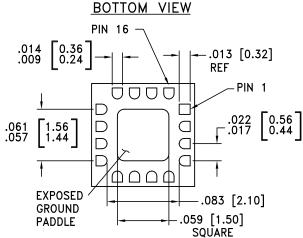
Power Supply Voltage (Vcc)	Vcc -0.5 V to 3.75 V	
Input Signals	Vcc - 2.0 V to Vcc + 0.5 V	
Output Signals	Vcc - 1.5 V to Vcc + 0.5 V	
Continuous Pdiss (T = 85 °C) (derate 17 mW/°C above 85 °C)	0.68 W	
Thermal Resistance (R <sub>th j-p</sub> ) Worst case junction to package paddle	59 °C/W	
Maximum Junction Temperature	125 °C	
Storage Temperature	-65 °C to +150 °C	
Operating Temperature	-40 °C to +85 °C	



## **Outline Drawing**







#### NOTES:

- 1. PACKAGE BODY MATERIAL: ALUMINA
- 2. LEAD AND GROUND PADDLE PLATING:
- 30-80 MICROINCHES GOLD OVER 50 MICROINCHES MINIMUM NICKEL.
- 3. DIMENSIONS ARE IN INCHES [MILLIMETERS].
- 4. LEAD SPACING TOLERANCE IS NON-CUMULATIVE.
- 5. PACKAGE WARP SHALL NOT EXCEED 0.05 mm DATUM -C-
- 6. ALL GROUND LEADS MUST BE SOLDERED TO PCB RF GROUND.
- 7. PADDLE MUST BE SOLDERED TO GND.





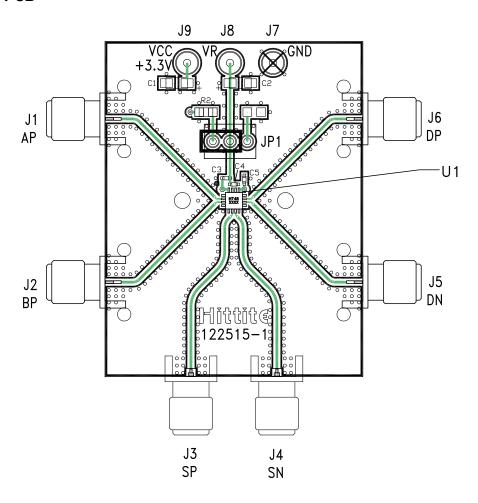
# **Pin Descriptions**

Pin Number	Function	Description	Interface Schematic
1, 4, 5, 8, 9, 12	GND	Signal Grounds	⊖ GND =
2, 3	АР, ВР	Single-Ended Data Inputs: Current Mode Logic (CML) referenced to positive supply.	GND O VCC
6, 7	SP, SN	Differential Select Inputs: Current Mode Logic (CML) referenced to positive supply.	GND O O SN
10, 11	DN, DP	Differential Data Outputs: Current Mode Logic (CML) referenced to positive supply.	GND O O DN
13, 16	Vcc	Positive Supply	
14, Package Base	GND	Supply Ground	GND =
15	VR	Output level control. Output level may be adjusted by applying a voltage to VR per "Output Differential vs. VR" plot.	VR O





#### **Evaluation PCB**



### List of Materials for Evaluation PCB 122517 [1]

Item	Description
J1 - J6	PCB Mount SMA RF Connectors
J7 - J9	DC Pin
JP1	Shorting Jumper
C1, C2	4.7 μF Capacitor, Tantalum
C3 - C5	100 pF Capacitor, 0402 Pkg.
R2	10 Ohm Resistor, 0603 Pkg.
U1	HMC748LC3C High Speed Logic, 2:1 Selector
PCB [2]	122515 Evaluation Board

<sup>[1]</sup> Reference this number when ordering complete evaluation PCB

The circuit board used in the application should use RF circuit design techniques. Signal lines should have 50 Ohm impedance while the package ground leads should be connected directly to the ground plane similar to that shown. The exposed package base should be connected to GND. A sufficient number of via holes should be used to connect the top and bottom ground planes. The evaluation circuit board shown is available from Hittite upon request. Install jumper on JP1 to short VR to Vcc for normal operation.

<sup>[2]</sup> Circuit Board Material: Arlon 25FR or Rogers 4350





# **Application Circuit**

